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Herring et al.

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(54) **POWER CONNECTOR ASSEMBLY**

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H01R 12/58 (2011.01)

(52) **U.S. Cl.**
CPC ***H01R 25/162*** (2013.01); ***H01R 12/585*** (2013.01); ***H01R 13/6215*** (2013.01)

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See application file for complete search history.

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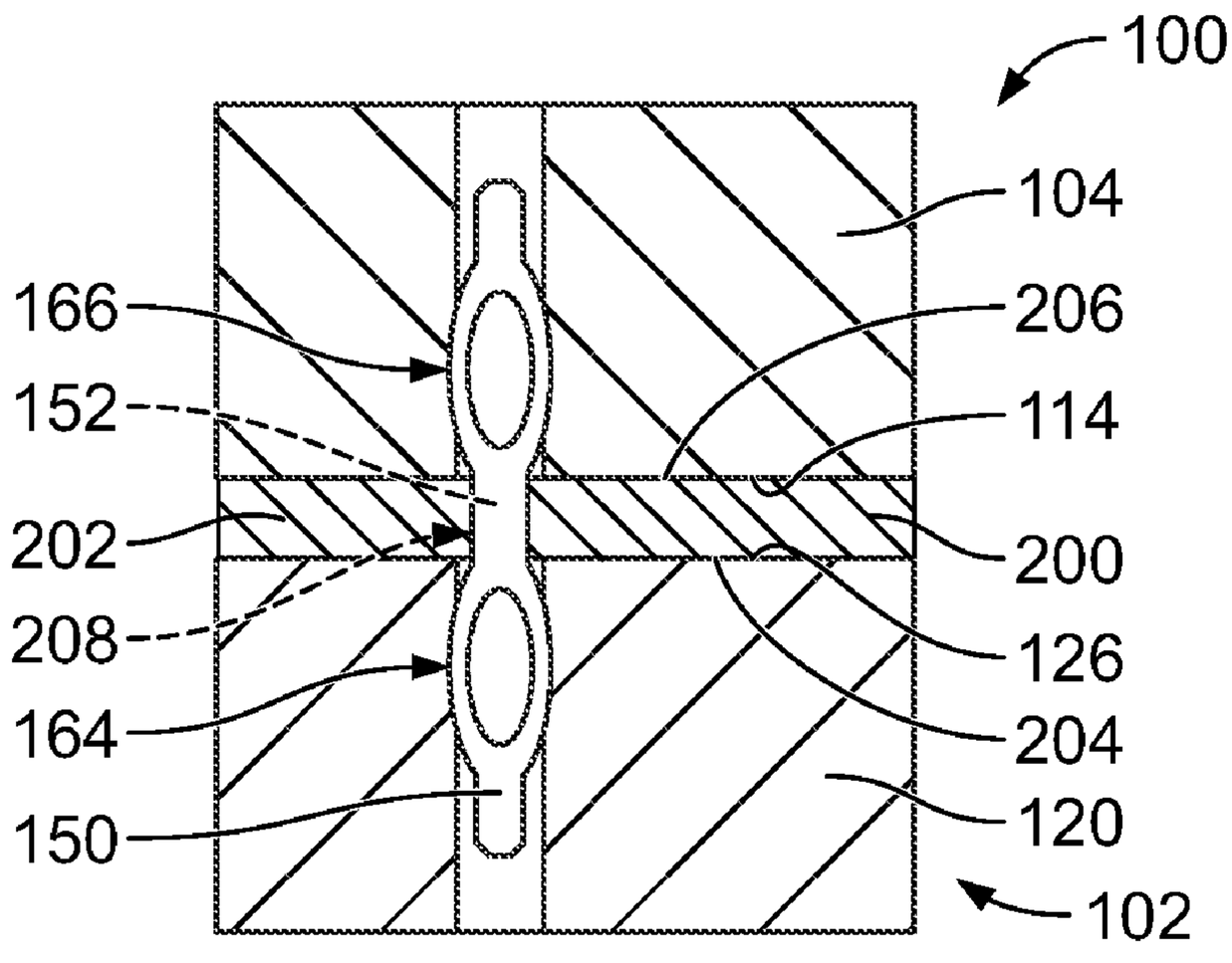
Primary Examiner — Harshad C Patel

(57) **ABSTRACT**

A power connector assembly includes a busbar having a mounting surface and openings extending into the busbar being open at the mounting surface and power contacts arranged in a power contact array electrically connected to the busbar. Each power contact includes a main body, a first compliant pin extending from the main body, and a second compliant pin extending from the main body. The first compliant pin is received in the corresponding opening of the busbar to electrically connect the power contact to the busbar. The second compliant pin is configured to be received in a plated via of a printed circuit board to electrically connect the power contact to the printed circuit board. The power contact array mechanically and electrically connects the busbar to the printed circuit board.

20 Claims, 4 Drawing Sheets



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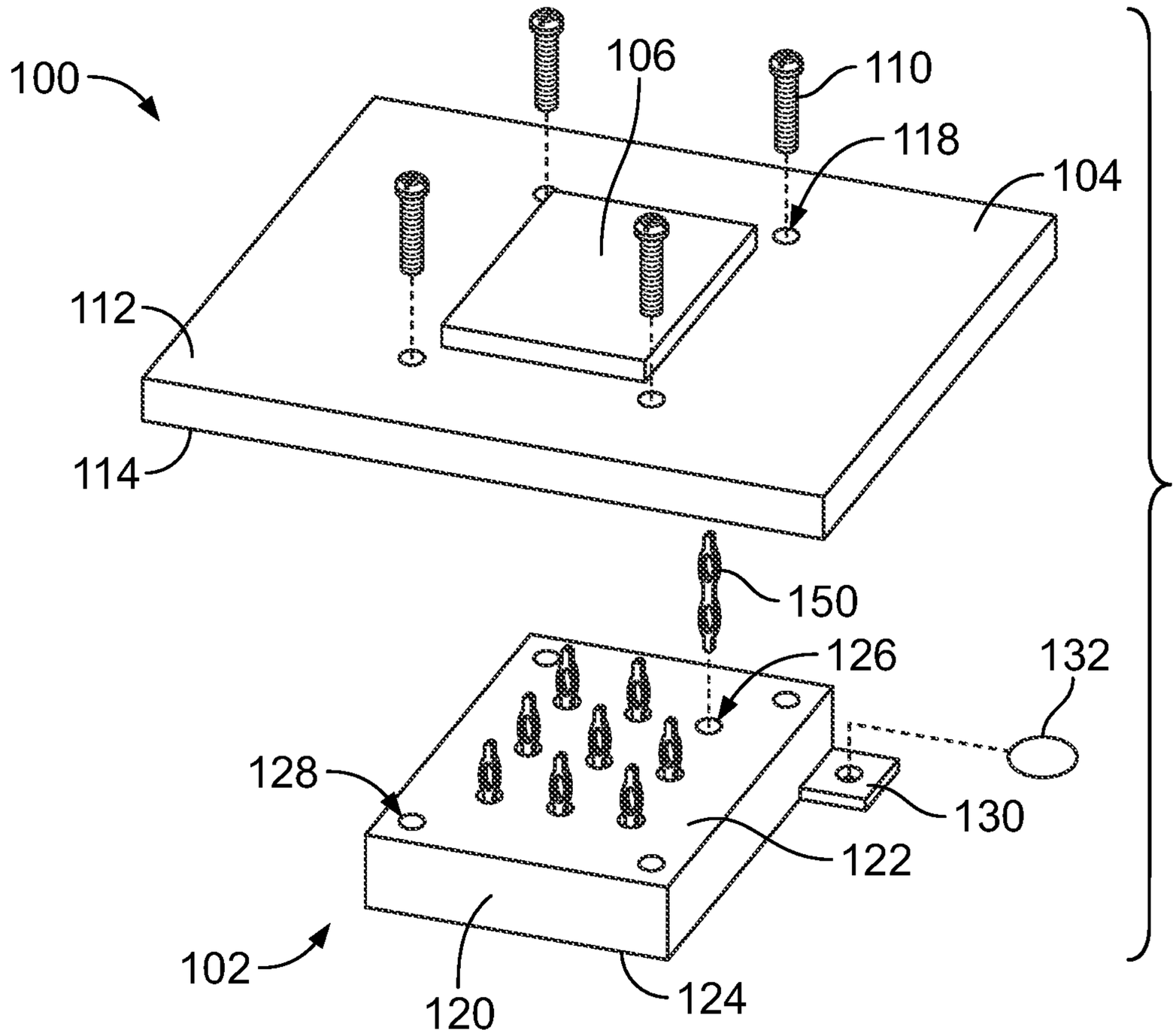
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106
110
118
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132
128
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102
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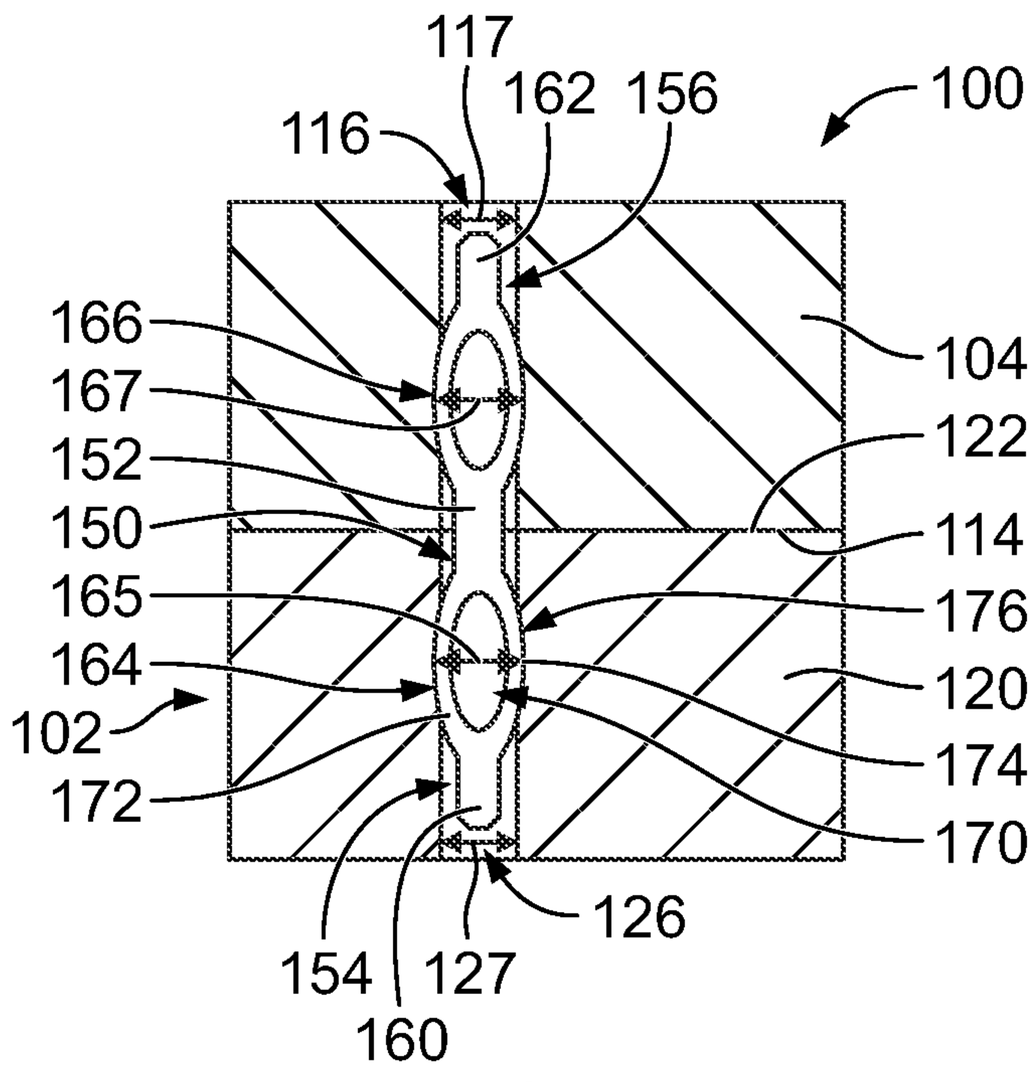
124

FIG. 1


117
162
156
100
116
166
167
152
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164
102
172
104
122
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120
174
170
126
154
127
160

FIG. 2

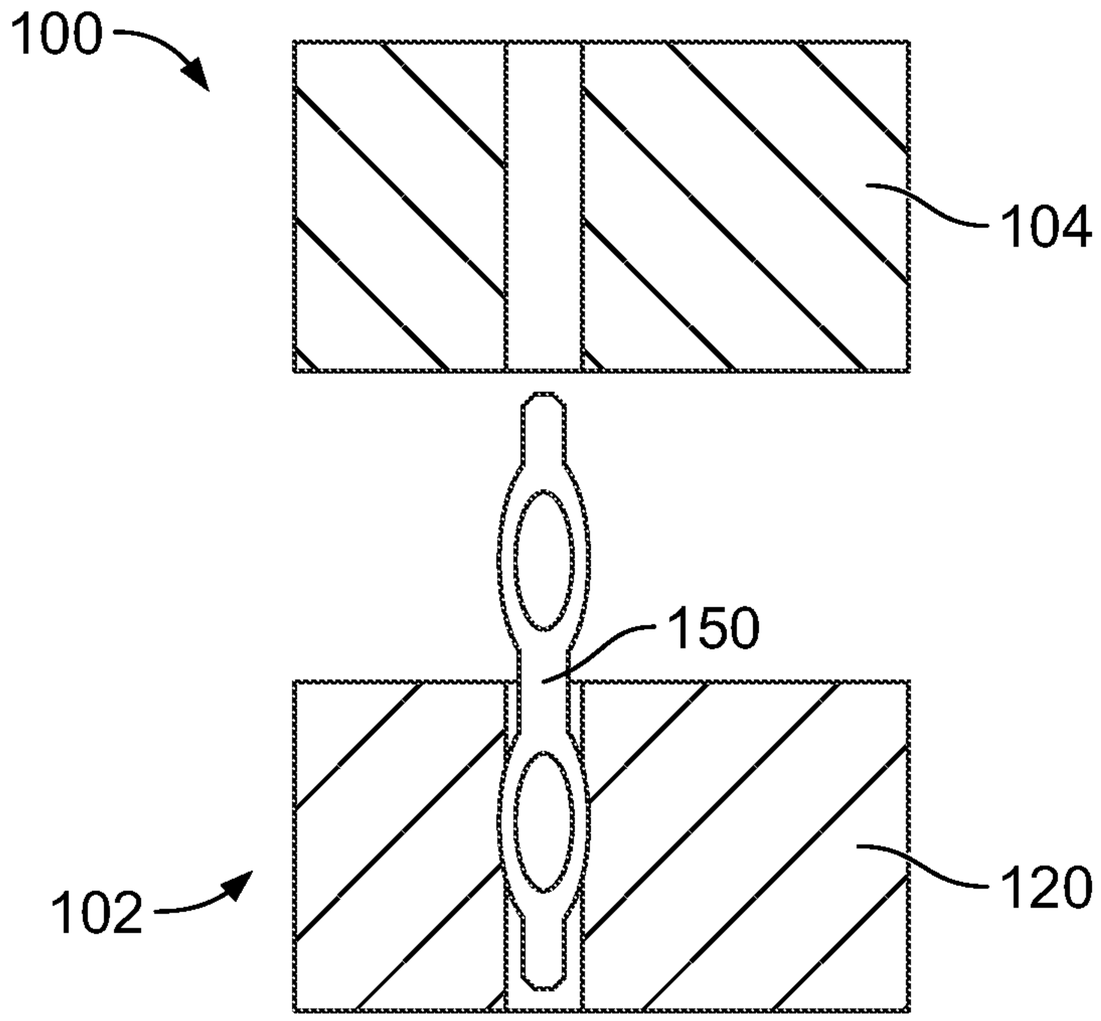


FIG. 3

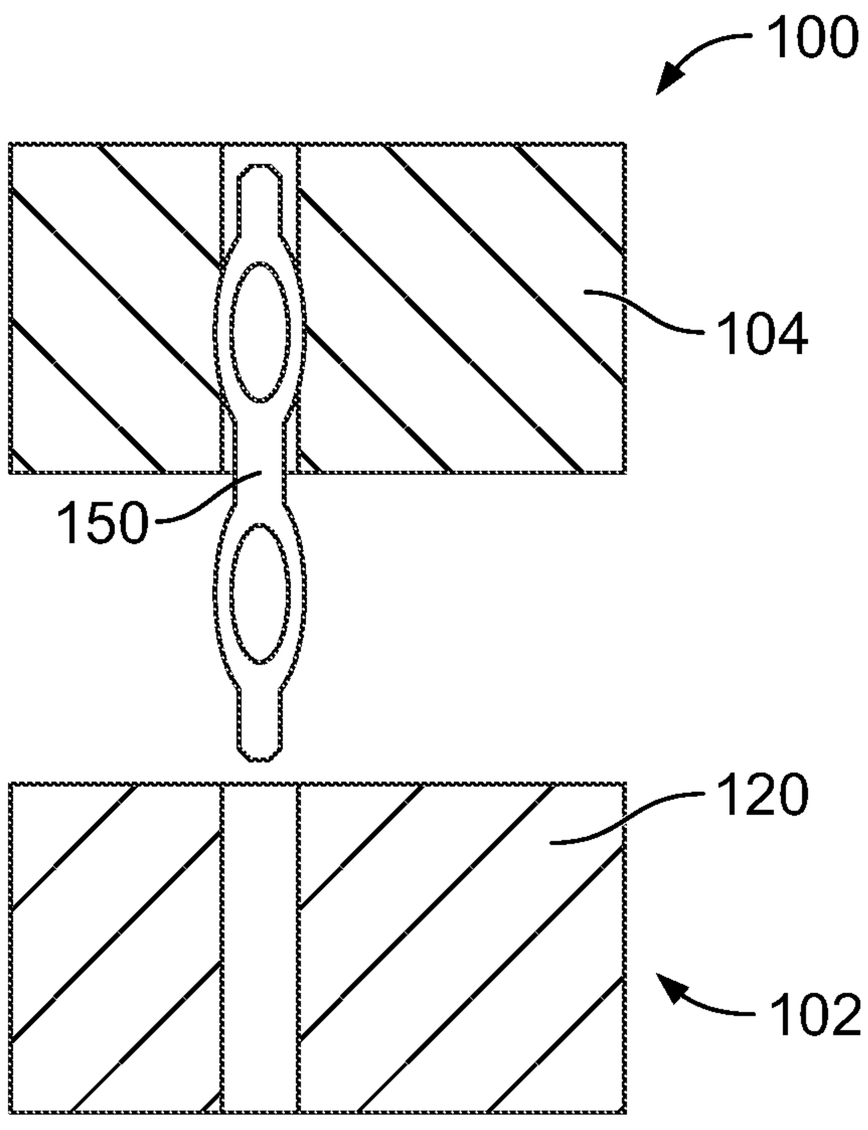


FIG. 4

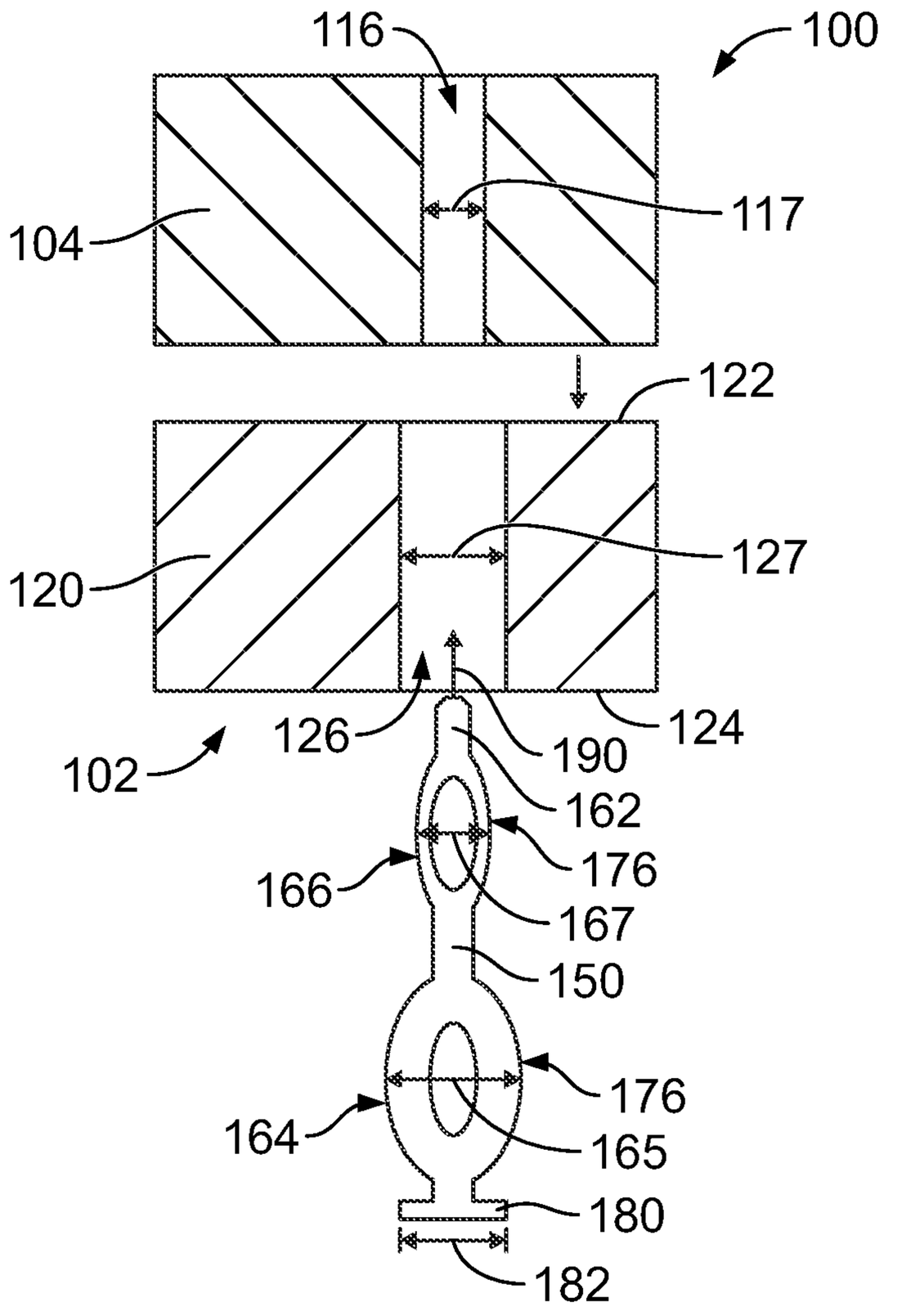

116
100
104
117
122
120
127
126
124
102
190
162
176
166
167
150
176
164
165
180
182

FIG. 5

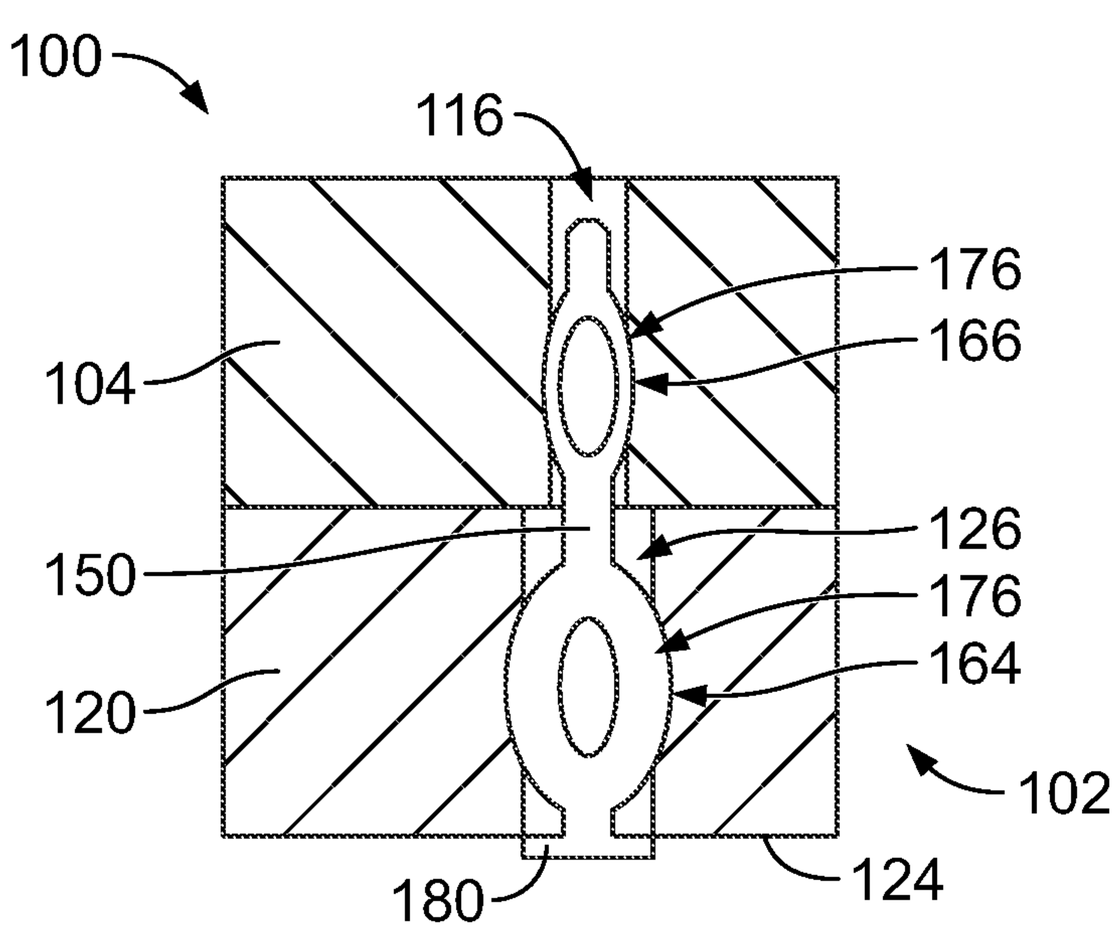

100
116
176
166
104
126
150
176
120
164
102
180
124

FIG. 6

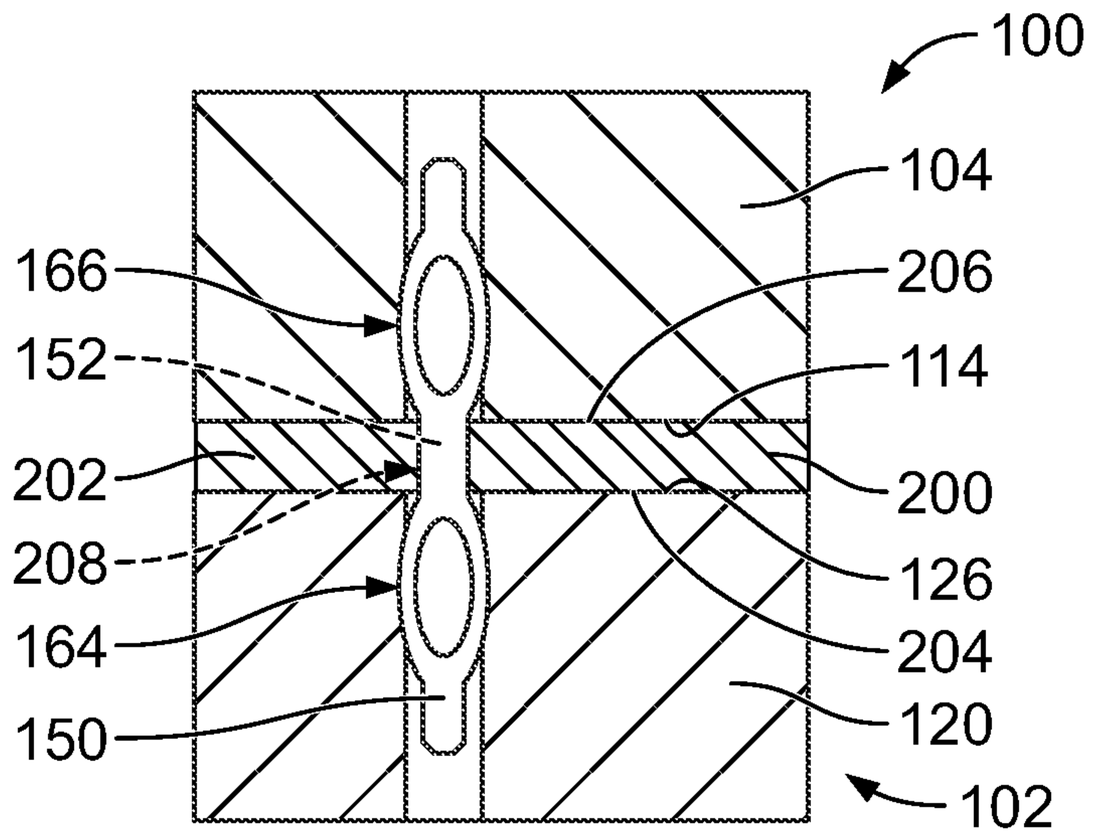
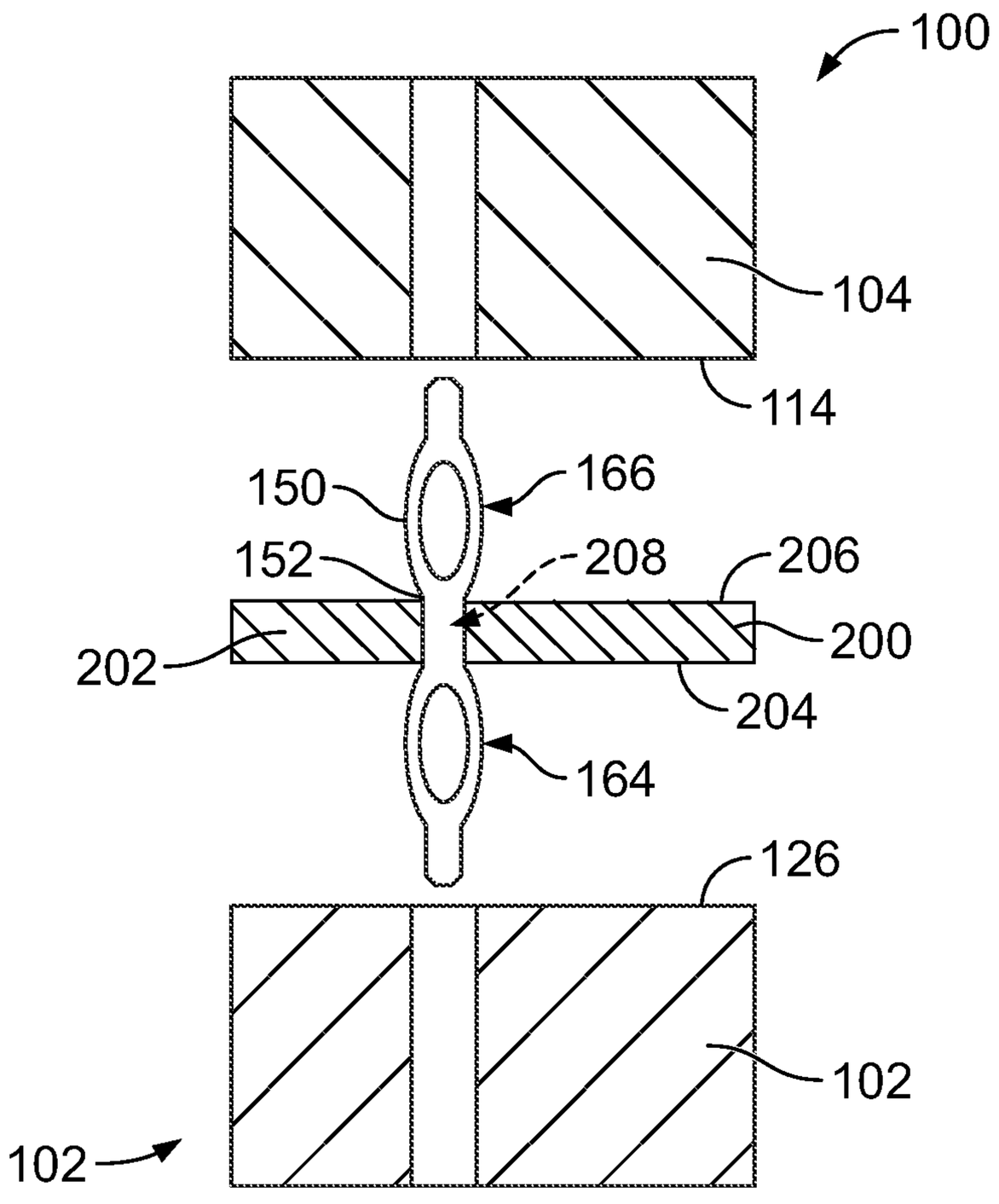

100
104
166
206
152
114
202
200
208
126
164
204
150
120
102

FIG. 7


100
104
114
150
166
152
208
206
202
200
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164
126
102
102

FIG. 8

POWER CONNECTOR ASSEMBLY

BACKGROUND OF THE INVENTION

The subject matter herein relates generally to a power connector assembly.

Power connectors are used to supply power to components, such as a printed circuit board. Power is transmitted by the printed circuit board, via traces, to components connected to the printed circuit board. However, long trace lengths lead to poor power transfer due to resistance along the traces. Some systems supply the power in close proximity to the components. However, mounting the power connector to the printed circuit board requires fasteners that stress the printed circuit board when tightened, which may cause damage to nearby components or areas of the printed circuit board.

A need remains for a power connector assembly that may be coupled to a printed circuit board in a reliable manner.

BRIEF DESCRIPTION OF THE INVENTION

in one embodiment, a power connector assembly is provided including a busbar having a mounting surface and openings extending into the busbar being open at the mounting surface and power contacts arranged in a power contact array electrically connected to the busbar. Each power contact includes a main body, a first compliant pin extending from the main body, and a second compliant pin extending from the main body. The first compliant pin is received in the corresponding opening of the busbar to electrically connect the power contact to the busbar. The second compliant pin is configured to be received in a plated via of a printed circuit board to electrically connect the power contact to the printed circuit board. The power contact array mechanically and electrically connects the busbar to the printed circuit board.

In another embodiment, a power connector assembly is provided including a busbar having a mounting surface and openings extending into the busbar being open at the mounting surface, and power contacts arranged in a power contact array electrically connected to the busbar. Each power contact includes a main body, a head at a first end of the power contact, and a tip at a second end of the power contact. The power contact has a first compliant pin between the main body and the head. The power contact has a second compliant pin between the main body and the tip. The power contact is loaded into the busbar and the printed circuit board in a loading direction with the tip passing through both the busbar and the printed circuit board. The head is coupled to the busbar. The first compliant pin is received in the corresponding opening of the busbar to electrically connect the power contact to the busbar. The second compliant pin is configured to be received in a plated via of the printed circuit board to electrically connect the power contact to the printed circuit board. The power contact array, mechanically and electrically connects the busbar to the printed circuit board.

In a further embodiment, a power connector assembly is provided including a busbar having a mounting surface facing a mounting surface of a printed circuit board. The busbar has openings extending into the busbar open at the mounting surface. The power connector assembly includes a carrier positioned between the busbar and the printed circuit board. The carrier has a first surface and a second surface and has carrier openings therethrough. The first surface faces the mounting surface of the busbar. The second surface faces the mounting surface of the printed circuit board. The power connector assembly includes power contacts arranged in a power contact array. The power contacts are received in corresponding carrier openings. Each power contact includes a main body, a first compliant pin extending from the main body, and a second compliant pin extending from the main body. The main body is coupled to and held by the carrier. The first compliant pin is received in the corresponding opening of the busbar to electrically connect the power contact to the busbar. The second compliant pin is configured to be received in a plated via of a printed circuit board to electrically connect the power contact to the printed circuit board. The power contact array mechanically and electrically connects the busbar to the printed circuit board.

BRIEF DESCRIPTION OF THE DRAWINGS

FIG. **1** illustrates an electrical system including a power connector assembly in accordance with an exemplary embodiment.

FIG. **2** is a cross-sectional view of a portion of the electrical system and the power connector assembly in accordance with an exemplary embodiment,

FIG. **3** is a cross-sectional view of a portion of the electrical system and the power connector assembly in accordance with an exemplary embodiment showing components of the electrical system during assembly.

FIG. **4** is a cross-sectional view of a portion of the electrical system and the power connector assembly in accordance with an exemplary embodiment showing components of the electrical system during assembly.

FIG. **5** is a cross-sectional view of a portion of the electrical system and the power connector assembly in accordance with an exemplary embodiment showing components of the electrical system during assembly.

FIG. **6** is a cross-sectional view of a portion of the electrical system and the power connector assembly in accordance with an exemplary embodiment showing components of the electrical system in an assembled state.

FIG. **7** is a cross-sectional view of a portion of the electrical system and the power connector assembly in accordance with an exemplary embodiment showing components of the electrical system in an assembled state.

FIG. **8** is a cross-sectional view of a portion of the electrical system and the power connector assembly in accordance with an exemplary embodiment showing components of the electrical system during assembly.

DETAILED DESCRIPTION OF THE INVENTION

FIG. **1** illustrates an electrical system **100** including a power connector assembly **102** in accordance with an exemplary embodiment. The power connector assembly **102** is used to supply power to a printed circuit board **104**, such as for powering one or more electrical components **106** coupled to the printed circuit board **104**. In an exemplary embodiment, the power connector assembly **102** is electrically connected to the printed circuit board **104** proximate to the electrical component **106**. As such, the length of power transmission along the printed circuit board **104**, such as along conductive traces of the printed circuit board **104**, is reduced for efficient power transfer to the electrical component **106**. In an exemplary embodiment, the power connector assembly **102** has a press-fit connection interface to the printed circuit board **104**.

The power connector assembly **102** includes a busbar **120** and power contacts **150** arranged in a power contact array coupled between the busbar **120** and the printed circuit

board **104**. The power contacts **150** provide mechanical and electrical connections between the busbar **120** and the printed circuit board **104**. In an exemplary embodiment, the power contacts **150** are double-sided press-fit pin contacts. The press-fit interface between the power contacts **150** and the busbar **120** provide a reliable electrical interface between the power contacts **150** and the busbar **120**. The press-fit interface between the power contacts **150** and the printed circuit board **104** provide a reliable electrical interface between the power contacts **150** and the printed circuit board **104** in an exemplary embodiment, the power contacts **150** are terminated to the busbar **120** and the printed circuit board **104** at solderless interfaces to reduce the risk of damage to the printed circuit board **104** of exposing the printed circuit board **104** to extreme temperatures during the soldering process. In an exemplary embodiment, the power contacts **150** provide a mechanical interface between the busbar **120** and the printed circuit board **104** to reduce or eliminate the need for securing hardware therebetween thus reducing the risk of damage to the printed circuit board **104** from the use of high clamping pressure from securing hardware. Strain and damage to the printed circuit board **104** is reduced with the use of the press-fit compliant pins of the power contacts **150**.

The busbar **120** is manufactured from a metal material, such as copper or aluminum. The busbar **120** is a metal plate in various embodiments. The busbar **120** electrically connects each of the power contacts **150**. Power is transmitted through the body of the busbar **122** each of the power contacts **150**. The busbar **120** includes an upper surface **122** and a lower surface **124**. In the illustrated embodiment, the upper surface **122** defines a mounting surface that faces the printed circuit board **104**. The upper surface **122** may be referred to hereinafter as a mounting surface **122**. In alternative embodiments, the lower surface **124** may define the mounting surface, such as when the busbar **120** is located above the printed circuit board **104**.

The busbar **120** includes openings **126** extending at least partially through the busbar **120**. The openings **126** are open at the mounting surface **122**. The openings **126** receive corresponding power contacts **150**. In the illustrated embodiment, the openings **126** have a circular cross-section; however, the openings **126** may have other shapes in alternative embodiments the openings **126** are sized and shaped to receive ends of the power contacts **150**. For example, the openings **126** may have a width slightly smaller than the width of the end of the power contact **150** such that the power contacts are deformed when loaded into the openings **126** to form an interference fit between the power contacts **150** and the busbar **120**. Optionally, the openings **126** may extend entirely through the busbar **120**. In various embodiments, the openings **126** may be plated or coated with a conductive layer.

In an exemplary embodiment, the busbar **120** includes mounting openings **128** configured to receive fasteners **110** to secure the printed circuit board **104** to the busbar **120**. However, in alternative embodiments, the busbar **120** may be coupled to the printed circuit board **104** using only the power contacts **150**. For example, the press-tit interfaces provided by the power contacts **150** may be sufficient to mechanically coupled the busbar **120** into the printed circuit board **104**.

In an exemplary embodiment, the busbar **120** includes a terminal **130** configured to be electrically connected to a power supply **132** that supplies power to the busbar **120**. The terminal **130** may include a weld pad for welding a power wire to the terminal **130**. In other various embodiments, the terminal **130** may include an opening to receive a power terminal. Other types of electrical connections may be provided in alternative embodiments.

The printed circuit board **104** includes an upper surface **112** and a lower surface **114**. The printed circuit board **104** may include multiple layers between the upper surface **112** and the lower surface **114**. The printed circuit board **104** includes printed circuits, such as traces, pads, vias, and the like extending through or along surfaces of the layers of the printed circuit board **104**. In an exemplary embodiment, the lower surface **114** defines a mounting surface of the printed circuit board **104** and may be referred to hereinafter as a mounting surface **114**. The mounting surface **114** faces the busbar **120**. in alternative embodiments, the upper surface **112** may define a mounting surface that faces the busbar **120**, such as when the printed circuit board **104** is located below the busbar **120**.

In an exemplary embodiment, the printed circuit board **104** includes a plurality of plated vias **116** (shown in FIG. **2**) that receive ends of the power contacts **150**. The power contacts **150** are electrically connected to the printed circuit board **104** at the plated vias **116**. The ends of the power contacts **150** may be press-fit into the plated vias **116**. The busbar **120** is electrically connected to the electrical component **106** through the power contacts **150** and the plated vias **116**.

In an exemplary embodiment, the printed circuit board **104** includes mounting openings **118** through the substrate of the printed circuit board **104** that receive the fasteners **110**. The fasteners **110** are used to secure the printed circuit board **104** to the busbar **120**. The fasteners **110** may be threaded fasteners. The fasteners **110** provide clamping pressure between the printed circuit board **104** in the busbar **120** to resist uncoupling of the busbar **120** from the printed circuit board **104** for the life of the electrical system **100**. The amount of clamping force needed from the fasteners **110** is reduced by the positive mechanical connection provided by the press-fit connections of the power contacts **150**.

FIG. **2** is a cross-sectional view of a portion of the electrical system **100** in accordance with an exemplary embodiment. FIG. **2** illustrates the power connector assembly **102** coupled to the printed circuit board **104**. The busbar **120** of the power connector assembly **102** is mechanically and electrically connected to the printed circuit hoard **104** by the power contact **150** (only one power contact **150** of the power contact array is illustrated in FIG. **2**). The mounting surface **122** of the busbar **120** faces the mounting surface **114** of the printed circuit hoard **104**. The power contact **150** spans the interface between the busbar **120** and the printed circuit board **104**. The power contact **150** extends into the opening **126** of the busbar **120** and extends into the plated via **116** of the printed circuit board **104**. Ends of the power contacts **150** are press-fit coupled to the busbar **120** and press-fit coupled to the printed circuit board **104**.

The power contact **150** includes a main body **152** between a first end **154** and a second end **156**. The power contact **150** is manufactured fr©m a metal material, such as a copper material. In an exemplary embodiment, the power contact **150** is a stamped and formed contact with the main body **152** being integral with the first end **154** and the second end **156**. In the illustrated embodiment, the power contact **150** includes a first tip **160** at the distal end of the first end **154** and a second tip **162** at the distal end of the second end **156**. The first tip **160** has a reduced cross-section to guide loading into the opening **126** of the busbar **120**. The second tip **162** has a reduced cross-section to guide loading into the plated via **116** of the printed circuit board **104**.

In an exemplary embodiment, the power contact **150** includes double-sided press-fit pins configured to be press-fit into the busbar **120** and into the printed circuit board **104**. The power contact **150** includes a first compliant pin **164** at the first end **154** and a second compliant pin **166** at the second end **156**. The first compliant pin **164** is configured to be press-fit to the busbar **120** in the opening **126**. The second compliant pin **166** is configured to be press-fit into the printed circuit board **104** in the plated via **116**. In the illustrated embodiment, the compliant pins **164**, **166** are eye-of-the-needle pins. For example, each compliant pin **164**, **166** includes an opening **170** flanked on opposite sides by a first compliant beam **172** and a second compliant beam **174**. The compliant beams **172**, **174** and the opening **170** form a compliant section. The compliant section **176** is configured to be deformed when press-fit into the busbar **120** or the printed circuit board **104** for example, the compliant beams **172**, **174** may be compressed inward into the opening **170**. Such compression causes elastic deformation of the compliant section **176**, which causes the compliant beams **172**, **174** to spring outward against the busbar **120** or the printed circuit board **104** to form a mechanical and electrical connection with the busbar **120** or the printed circuit board **104**. The main body **152** connects the compliant sections **176**.

In an exemplary embodiment, the first and second compliant pins **164**, **166** may be identical to each other and inverted at opposite ends of the power contact **150**. However, in alternative embodiments, the first and second compliant pins **164**, **166** may be sized and shaped differently from each other. In an exemplary embodiment, the first compliant pin **164** has a first width **165** and the second compliant pin **166** has a second width **167**. Optionally, the first and second widths **165**, **167** may be equal to each other. However, in alternative embodiments, the first and second widths **165**, **167** may be different from each other. In an exemplary embodiment, the opening **126** in the busbar **120** has an opening width **127**. The first width **165** may be slightly greater than the opening width **127** such that the compliant section **176** of the first compliant pin **164** is compressed when the first compliant pin **164** is received in the opening **126**. In an exemplary embodiment, the plated via **116** in the printed circuit board **104** has a via width **117**. The second width **167** may be slightly greater than the via width **117** such that the compliant section **176** of the second compliant pin **166** is compressed when the second compliant pin **166** is received in the plated via **116**. In the illustrated embodiment, the via width **117** is approximately equal to the opening width **127**. However, the opening **126** may be wider than the plated via **116** in various embodiments, or vice versa.

FIG. **3** is a cross-sectional view of a portion of the electrical system **100** in accordance with an exemplary embodiment showing components of the electrical system **100** during assembly. FIG. **4** is a cross-sectional view of a portion of the electrical system **100** in accordance with an exemplary embodiment showing components of the electrical system **100** during assembly. FIG. **3** illustrates the power contact **150** coupled to the busbar **120** prior to assembly to the printed circuit board **104**. FIG. **4** illustrates the power contact **150** coupled to the printed circuit board **104** prior to assembly to the busbar **120**. The power contacts **150** may be preassembled to either component during assembly. In an exemplary embodiment, each of the power contacts **150** are preassembled to one of the components (for example the busbar **120** or the printed circuit board **104**) prior to assembly of the busbar **120** with the printed circuit board **104**. As such, all of the power contacts **150** may be mated to the other component (for example, the printed circuit board **104** or the busbar **120**) simultaneously.

FIG. **5** is a cross-sectional view of a portion of the electrical system **100** in accordance with an exemplary embodiment showing components of the electrical system **100** during assembly. FIG. **6** is a cross-sectional view of a portion of the electrical system **100** in accordance with an exemplary embodiment showing components of the electrical system **100** in an assembled state.

In an exemplary embodiment, the power contact **150** includes a head **180** at the first end **154**. The head **180** is provided in lieu of the first tip **160** (shown in FIG. **2**). The first compliant pin **164** is located between the main body **152** and the head **180**. The second compliant pin **166** is located between the main body **152** and the second tip **162**. In an exemplary embodiment, the power contact **150** is configured to be loaded into the busbar **120** and the printed circuit board **140** in a loading direction **190**. The tip **162** passes through both the busbar **120** and the printed circuit board **140** as the power contact is loaded in the loading direction **190**.

When assembled, the head **180** is configured to engage the busbar **120** (or the printed circuit board **104** when coupled to the printed circuit board **104**) to locate the power contact **150** relative to the busbar **120**. For example, during assembly, the power contact **150** may be loaded through the opening **126** until the head **180** bottoms out (i.e., abuts against) against the lower surface **124** of the busbar **120**. Optionally, the head **180** may sit generally flush with the surface of the busbar **120**. Optionally, the busbar **120** may include recessed notches that receive the head **180** such that the head **180** is recessed into the busbar **120**. In an exemplary embodiment, the head **180** has a head width **182** greater than the opening width **127** of the opening **126**. The head **180** provides a loading stop for the power contact **150** into the busbar **120**.

In various embodiments, multiple heads **180** of different power contacts **150** may be connected together, such as by a connecting beam between the heads **180**. For example, two of the power contacts **150** may be connected together to form a power staple defined by the two power contacts and the head **180**, or connecting beam, therebetween. In other various embodiments, greater than two power contacts **150** may be ganged together in a row by connecting beams between each of the heads of the power contacts **150**. For example, the power contacts **150** may be stamped with the connecting beams therebetween such that the power contacts **150** and the connecting beams are integral with each other formed from a single stamping process.

During assembly, the power contact **150** is loaded into the busbar **120** by initially passing the second compliant pin **166** through the opening **126** followed by the first compliant pin **164** being received in the opening **126**. For example, the power contact **150** may be loaded through the busbar **120** through the lower surface **124**. Optionally, the power contacts **150** may be preloaded into the busbar **120** prior to assembly and the power connector assembly **102** to the printed circuit board **104**. However, in alternative assembly process, the busbar **120** and the printed circuit board **104** may be aligned with each other such that the openings **126** are aligned with the plated vias **116**. The power contacts **150** may then be loaded into both the busbar **120** and the printed circuit board **104** in a single loading process. For example, the second compliant pin **166** passes through the opening **126** in the busbar **120** straight into the plated via **116** of the printed circuit board **104**. As such, the assembly process may be simplified by simultaneously mating the first com-

pliant pin **164** with the busbar **120** and the second compliant pin **166** with the printed circuit board **104**. The power contact **150** is loaded into the busbar **120** and the printed circuit board **104** until the head **180** bottoms out against the busbar **120**.

In an exemplary embodiment, to pass the second compliant pin **166** through the busbar **120** without damaging the compliant section **176** of the second compliant pin **166**, the opening **126** is wider than the second width **167** of the second. compliant pin **166**. As such, the second compliant pin **166** is able to pass, unobstructed lady, through the busbar **120**. In the illustrated embodiment, the first compliant pin **164** is a first width **165** and is wider than the second width **167** of the second compliant pin **166**. The first compliant pin **164** is wider for interfacing with the wider opening **126**. The second compliant pin **166** is narrower for interfacing with the narrower plated via **116**,

In an exemplary embodiment, the head **180** allows the power connector assembly **102** to be disassembled. For example, for disassembly, the busbar **120** is separated from the printed circuit board **104**. Movement of the busbar **120** away from the printed circuit board **104** pulls all of the power contacts **150** from of the plated vias of the printed circuit board **104**. The heads **180** of the power contacts **150** allow disassembly of the printed circuit board **104** without damaging the printed circuit board **104** and without having any of the power contacts **150** stuck in the plated vias **116** of the printed circuit board **104**. As such, the printed circuit board **104** may be reused, such as by coupling a different power connector assembly **102** to the printed circuit board **104**.

FIG. **7** is a cross-sectional view of a portion of the electrical system **100** in accordance with an exemplary embodiment showing components of the electrical system **100** in an assembled state. FIG. **8** is a cross-sectional view of a portion of the electrical system **100** in accordance with an exemplary embodiment showing components of the electrical system **100** during assembly.

In an exemplary embodiment, the power connector assembly **102** includes a carrier **200** used to hold the power contacts **150** and the power contact array. When assembled, the carrier **200** is located between the mounting surfaces **122**, **114** of the busbar **120** and the printed circuit board **104**. The carrier **200** includes a substrate **202** that ties each of the power contacts **150** together as a unit. The carrier **200** makes assembly to the busbar **120** and/or the printed circuit board **104** simpler. In various embodiments, the carrier **200** may be a flexible film. In other various embodiments, the carrier **200** may be a rigid plate. Optionally, the carrier **200** may be electrically conductive to electrically connect to each of the power contacts **150**. In alternative embodiments, the carrier **200** may be manufactured from a dielectric material to provide electrical isolation between the busbar **120** and the mounting surface **114** of the printed circuit board **104**,

The carrier **200** includes a first surface **204** and a second surface **206**. The first surface **204** faces the mounting surface **122** of the busbar **120** and may be a bottom side in various embodiments. The second surface **206** faces the mounting surface **114** of the printed circuit board **104** and may be a top side in various embodiments. In an exemplary embodiment, the carrier **200** includes openings **208** therethrough. The openings **208** receive the main bodies **152** of the power contacts **150**. In various embodiments, the carrier **200** may be formed in place around the array of the power contacts **150**. For example, the carrier **200** may be molded around the main bodies **152** of the power contacts **150**. The first compliant pins **164** extend from the first surface **204**. The second compliant pins **166** extend from the second surface **206**. The first compliant pins **164** are used to secure the carrier **200** to the busbar **120**. The second compliant pins **166** are used to secure the carrier **200** to the printed circuit board **104**.

It is to be understood that the above description is intended to be illustrative, and not restrictive. For example, the above-described embodiments (and/or aspects thereof) may be used in combination with each other. In addition, many modifications may be made to adapt a particular situation or material to the teachings of the invention without departing from its scope. Dimensions, types of materials, orientations of the various components, and the number and positions of the various components described herein are intended to define parameters of certain embodiments, and are by no means limiting and are merely exemplary embodiments. Many other embodiments and modifications within the spirit and scope of the claims will be apparent to those of skill in the art upon reviewing the above description. The scope of the invention should, therefore, be determined with reference to the appended claims, along with the full scope of equivalents to which such claims are entitled. In the appended claims, the terms "including" and "in which" are used as the plain-English equivalents of the respective terms "comprising" and "wherein." Moreover, in the following claims, the terms "first," "second," and "third," etc. are used merely as labels, and are not intended to impose numerical requirements on their objects. Further, the limitations of the following claims are not written in means-plus-function format and are not intended to be interpreted based on 35 U.S.C. § 112(f), unless and until such claim limitations expressly use the phrase "means for" followed by a statement of function void of further structure.

What is claimed is:

1. A power connector assembly comprising:

a busbar having a mounting surface, the busbar including a metal block having openings extending into the metal block of the busbar, the openings being open at the mounting surface; and

power contacts arranged in a power contact array, the power contacts being electrically connected to the metal block of the busbar to electrically common the power contacts, each power contact including a main body, a first compliant pin extending from the main body, and a second compliant pin extending from the main body, the first compliant pin being received in the corresponding opening of the busbar to electrically connect the power contact to the busbar, the second compliant pin configured to be received in a plated via of a printed circuit board to electrically connect the power contact to the printed circuit board, wherein the power contact array mechanically and electrically connects the metal block of the busbar to the printed circuit board through the power contacts of the power contact array.

2. The power connector assembly of claim **1**, wherein the power contacts are double ended-press fit pins.

3. The power connector assembly of claim **1**, wherein the first compliant pin has a first width and the second compliant pin has a second width approximately equal to the first width.

4. The power connector assembly of claim **1**, wherein the openings in the busbar each have an opening width, the first compliant pin having a first width greater than the opening width, the second compliant pin having a second width less than the opening width.

5. The power connector assembly of claim 1, wherein the power contact includes a head at a first end of the power contact, the head being wider than the busbar opening to rest on the busbar when the power contact is coupled to the busbar.

6. The power connector assembly of claim 1, wherein a plurality of the power contacts are coupled together by a connecting beam, the connecting beam abutting against the busbar when the power contacts are coupled to the busbar.

7. The power connector assembly of claim 1, wherein the power contact has a first tip and a second tip at opposite ends of the power contact, the first compliant pin located between the main body and the first tip, the second compliant pin located between the main body and the second tip.

8. The power connector assembly of claim 1, further comprising a carrier holding a plurality of the power contacts, the carrier having a first surface and a second surface, the first compliant pins extending from the first surface, the second compliant pins extending from the second surface, the carrier located between the busbar and the printed circuit board.

9. The power connector assembly of claim 8, wherein the carrier is a flexible film.

10. The power connector assembly of claim 8, wherein the first compliant pins secure the carrier to the busbar, and wherein the second compliant pins secure the carrier to the printed circuit board.

11. The power connector assembly of claim 1, wherein the busbar has a terminal configured to be electrically connected to a power supply that supplies power to the busbar.

12. A power connector assembly comprising:

a busbar having a mounting surface, the busbar including a metal block having openings extending into the metal block of the busbar, the openings being open at the mounting surface; and

power contacts arranged in a power contact array, the power contacts being electrically connected to the metal block of the busbar to electrically common the power contacts, each power contact including a main body, a head at a first end of the power contact, and a tip at a second end of the power contact, the power contact having a first compliant pin between the main body and the head, the power contact having a second compliant pin between the main body and the tip, the power contact being loaded into the busbar and a printed circuit board in a loading direction with the tip passing through both the busbar and the printed circuit board, the head being coupled to the busbar, the first compliant pin being received in the corresponding opening of the busbar to electrically connect the power contact to the busbar, the second compliant pin configured to be received in a plated via of the printed circuit board to electrically connect the power contact to the printed circuit board, wherein the power contact array mechanically and electrically connects the metal block of the busbar to the printed circuit board through the power contacts of the power contact array.

13. The power connector assembly of claim 12, wherein the second compliant pin passes through the busbar into the corresponding plated via during loading to electrically connect the second compliant pin to the printed circuit board.

14. The power connector assembly of claim 12, wherein the first compliant pin is loaded into the busbar from above and wherein the second compliant pin is loaded into the busbar from above.

15. The power connector assembly of claim 12, wherein the openings in the busbar each have an opening width, the first compliant pin having a first width greater than the opening width, the second compliant pin having a second width less than the opening width.

16. The power connector assembly of claim 12, wherein the openings in the busbar each have an opening width, and wherein the plated vias each have a via width less than the opening width.

17. The power connector assembly of claim 12, wherein the openings are aligned with the plated vias to allow the power contacts to pass straight through the openings and the plated vias during loading.

18. A power connector assembly comprising:

a busbar having a mounting surface facing a mounting surface of a printed circuit board, the busbar including a metal block having openings extending into the metal block of the busbar, the openings being open at the mounting surface;

a carrier positioned between the busbar and the printed circuit board, the carrier having a first surface and a second surface, the carrier including carrier openings therethrough, the first surface facing the mounting surface of the busbar, the second surface facing the mounting surface of the printed circuit board;

power contacts arranged in a power contact array, the power contacts being received in corresponding carrier openings, each power contact including a main body, a first compliant pin extending from the main body, and a second compliant pin extending from the main body, the main body being coupled to and held by the carrier, the first compliant pin being received in the corresponding opening of the busbar to electrically connect the power contact to the metal block of the busbar to electrically common the power contacts, the second compliant pin configured to be received in a plated via of a printed circuit board to electrically connect the power contact to the printed circuit board, wherein the power contact array mechanically and electrically connects the metal block of the busbar to the printed circuit board through the power contacts of the power contact array.

19. The power connector assembly of claim 18, wherein the carrier is a flexible film.

20. The power connector assembly of claim 18, wherein the first compliant pins secure the carrier to the busbar, and wherein the second compliant pins secure the carrier to the printed circuit board.

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